

Two Photon Polymerization (2PP) Printers Selection Guideline

Primary contact: Sung Oh Woo, sung.woo@tamu.edu
Sr. Research Engineer
AggieFab
Texas A&M University

- Specifications
- Printer selection guideline
- Information on objective lens
- Information on both printers

2PP Printer Specifications

Item	Nanoscribe PPGT2	UpNano Nano One 1000
Max Laser power (mW)	180	1000
Laser Wavelength (nm)	780	780
Max Printing Speed (mm ³ /h)	6.8	300
Focus	Interferometer	2PP Laser
	Δn (resin & substrate)	Fluorescence intensity from resin
Autofocus	Yes	Limited to fluorescence resins
Substrate type	Si, glass, or ITO Restricted to resin & objective	Any surfaces
Max Substrate size	4" wafer	4" wafer
Max printing height	8 mm	42 mm
Printing mode	Top down	Top down, Bottom Up, & Vat
Tilt Correction	NO	YES

2PP Printer Selection Guideline

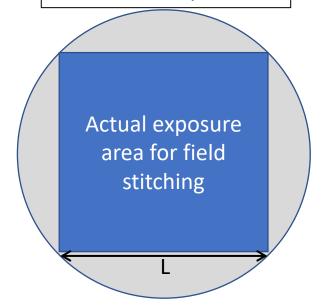
Criteria	Suggestion	PPGT2	Nano One	Note
Cost	N/A	One time setup fee \$20 Plus, flat rate \$10/h	\$75/h	
Resolution	Both	Lateral: \sim 200 nm Vertical: \sim 1 – 1.5 μ m	Lateral: ~220 nm Vertical: ~ 0.55 μm	Printing parameters, resins, objectives are critical
Throughput	Nano One	6.8 mm ³ /h	300 (mm ³ /h)	Nano One: practically > X10 faster
Substrate	Nano One	Si, glass, or ITO	All	Information - PPGT2 slide
Autofocus	PPGT2	All	Fluorescent resins, manual	
Large structure	Nano One	Height: <8 mm	Height: < 42 mm Tilt correction	
Customization	PPGT2	Laser power adjustment	N/A	PPGT2: allows printing a single structure with various laser power
Sample handling	Nano One	Taping Multi-sample loading	Vacuum holding Tilt correction Bio well plate	

Objective Lens Availability

- > Nanoscribe: 3 objectives are available
- > UpNano: 5 objectives are available

Objective view field

• L: side of square



Nanoscribe PPGT2		UpNano Nano One 1000					
Mag.	NA	WD (mm)	L (μm)	Mag.	NA	WD (mm)	L (μm)
				5X	0.25	12.5	1986
				10X	0.3	10	993
10X	0.3	0.7	354	10X	0.4	3.1	704
25X	0.8	0.38	283	20X	0.7	0.35	496
63X	1.4	0.36	141	40X	1.4	0.13	248

PPGT2 information

- > Developer: PGMEA
- > Due to autofocus method, only the following objective-substrate-resin combinations are allowed for printing
- > Only AggieFab-provided resins can be used

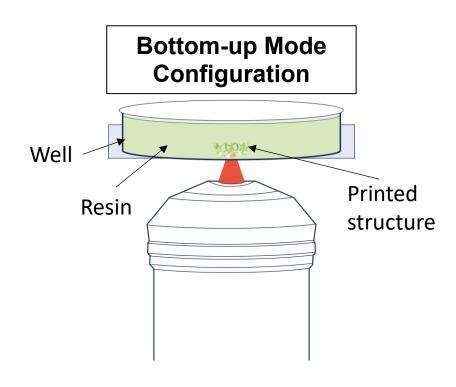
Objective	Substrate	Resin	Applications
10X Si	C;	IP-Q	Fast prototyping mm scale printing with micron scale precision
	31	GP-Silica	Glass printing, requiring sintering
25X ITO/glass	ITO/glass	IP-Visio	Low autofluorescence Biocompatible
	110/glass	IP-S	High mechanical stability with smooth surface Micro optics components
63X	Si, glass	IP-Dip	Fine structures
		IP-L	Fine features with mechanical stability

Nano One Information

Resin	Objective	Autofocus	Applications	Developer & post process
UpQuartz		0	Glass printing	PGMEA/sintering
UpBrix	40X	Ο	Ultra high resolution 2.5D structure printing	PGMEA or IPA
UpPhoto	All	O	High optical transparency Fast prototyping	IPA
UpFlow	10, 20, 40X	X	Low Autofluorescence Low viscosity	PEMEA or IPA UV exposure
UpOpto	10, 20, 40X	X	Ultra low Autofluorescence High optical transparency	PEMEA or IPA UV exposure

Nano One Bio Well-plate Package

- Well-plate stage insert is available for Nano One, enabling printing directly on a well-plate (up to 96 wells)
- Bottom-up printing mode is required
- ➤ Well Plate Dock software is available to streamline print job design
- > For high-aspect ratio structures, 5X or 10X (WD=10mm) objectives should be used



Well-plate stage insert



10X objective (WD=10mm)



